

TOSHIBA Bi-CMOS Digital Integrated Circuit Silicon Monolithic

TB2901H

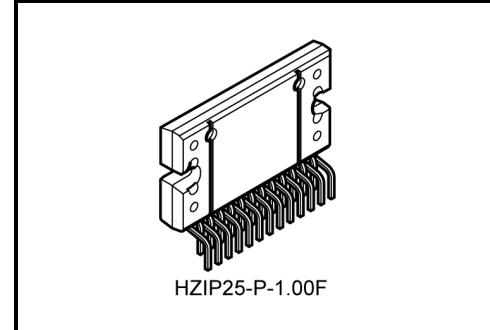
Maximum Power 47 W BTL x 4-ch Audio Power IC

The TB2901H is 4-ch BTL audio amplifier for car audio applications.

This IC can generate higher power: POUT MAX = 47 W as it includes the pure complementary P-ch and N-ch DMOS output stage.

It is designed to yield low distortion ratio for 4-ch BTL audio power amplifier, built-in standby function, muting function, and various kinds of protectors.

Additionally, high-side switch is built in.



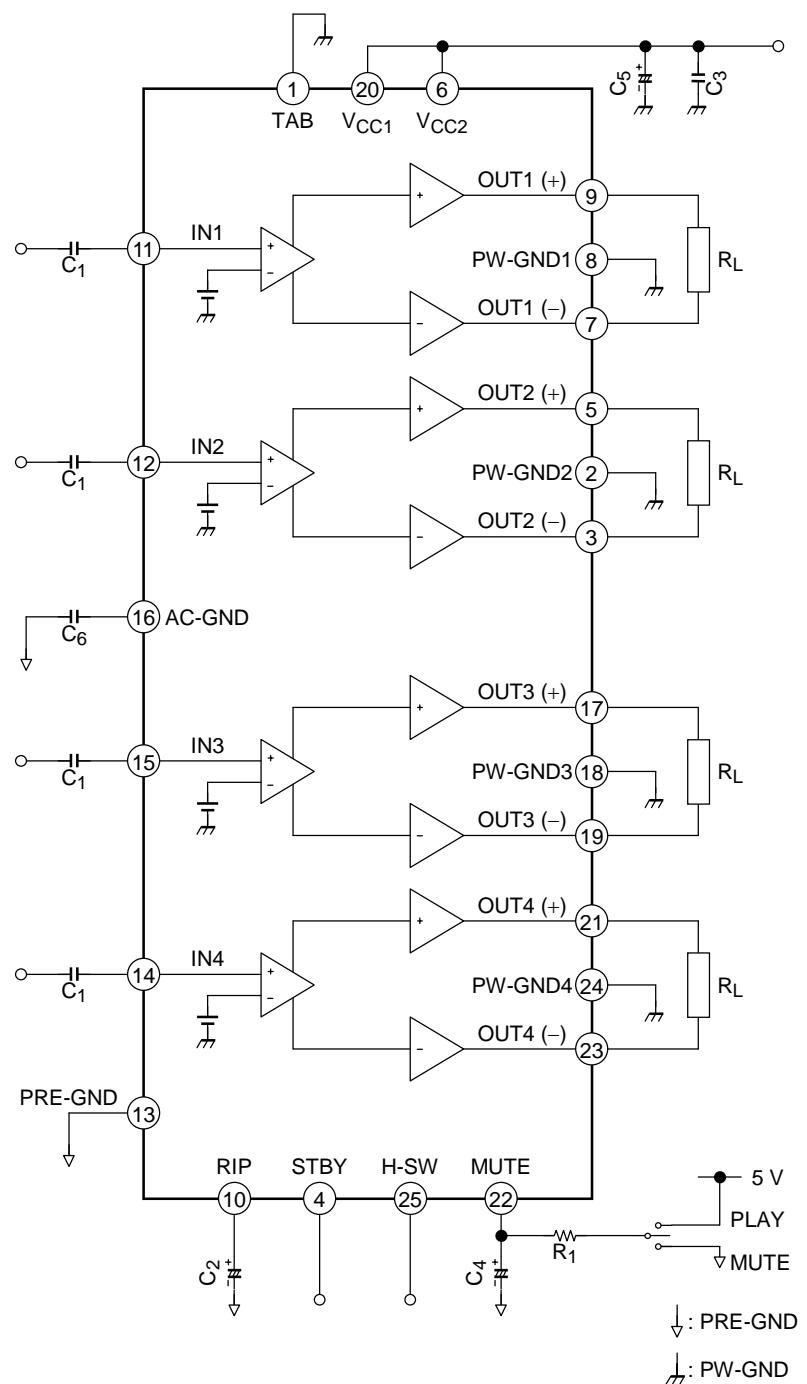
Weight: 7.7 g (typ.)

Features

- High power output
 - POUT MAX (1) = 47 W (typ.)
(VCC = 14.4 V, f = 1 kHz, JEITA max, RL = 4 Ω)
 - POUT MAX (2) = 43 W (typ.)
(VCC = 13.7 V, f = 1 kHz, JEITA max, RL = 4 Ω)
 - POUT (1) = 29 W (typ.)
(VCC = 14.4 V, f = 1 kHz, THD = 10%, RL = 4 Ω)
 - POUT (2) = 25 W (typ.)
(VCC = 13.2 V, f = 1 kHz, THD = 10%, RL = 4 Ω)
- Low distortion ratio: THD = 0.015% (typ.)
(VCC = 13.2 V, f = 1 kHz, POUT = 5 W, RL = 4 Ω)
- Low noise: VNO = 90 μVrms (typ.)
(VCC = 13.2 V, Rg = 0 Ω, BW = 20 Hz~20 kHz, RL = 4 Ω)
- Built-in standby switch function (pin 4)
- Built-in muting function (pin 22)
- Built-in high-side switch function (pin 25)
- Built-in various protection circuits:
Thermal shut down, overvoltage, out to GND, out to VCC, out to out short
- Operating supply voltage: VCC (opr) = 9~18 V (RL = 4 Ω)

Note 1: Since this device's pins have a low withstand voltage, please handle it with care.

Block Diagram



Caution and Application Method

1. Voltage Gain Adjustment

This IC has no NF (negative feedback) Pins. Therefore, the voltage gain can not be adjusted, but it makes the device a space and total costs saver.

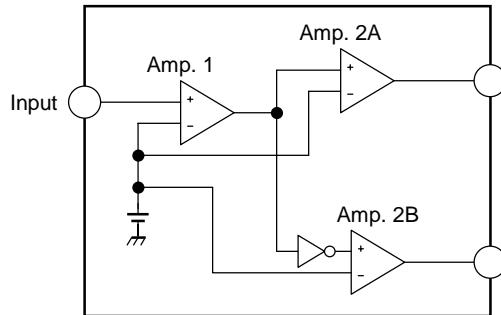


Figure 1 Block Diagram

The voltage gain of amp.1 : $G_{V1} = 0\text{dB}$

The voltage gain of amp.2A, B : $G_{V2} = 20\text{dB}$

The voltage gain of BTL connection: $G_V(\text{BTL}) = 6\text{dB}$

Therefore, the total voltage gain is decided by expression below.

$$G_V = G_{V1} + G_{V2} + G_V (\text{BTL}) = 0 + 20 + 6 = 26 \text{ dB}$$

2. Standby SW Function (pin 4)

By means of controlling pin 4 (standby pin) to High and Low, the power supply can be set to ON and OFF. The threshold voltage of pin 4 is set at about 3VBE (typ.), and the power supply current is about 2 μ A (typ.) in the standby state.

Control Voltage of Pin 4: V_{SB}

Standby	Power	V _{SB} (V)
ON	OFF	0~1.5
OFF	ON	3.5~6 V

When changing the time constant of pin 4, check the pop noise.

Advantage of Standby SW

- (1) Since VCC can directly be controlled to ON or OFF by the microcomputer, the switching relay can be omitted.
- (2) Since the control current is microscopic, the switching relay of small current capacity is satisfactory for switching.

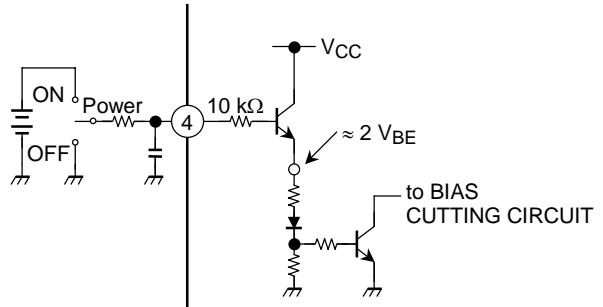


Figure 2 With pin 4 set to High, Power is turned ON

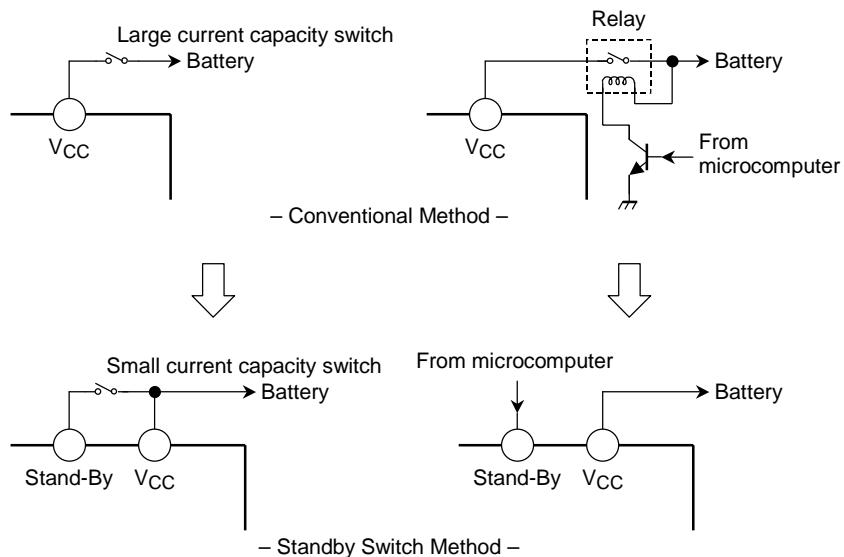


Figure 3

3. Muting Function (pin 22)

Audio muting function is enabled when pin 22 is Low. When the time constant of the muting function is determined by R_1 and C_4 , it should take into account the pop noise. The pop noise which is generated when the power or muting function is turned ON/OFF will vary according to the time constant. (Refer to Figure 4 and Figure 5.)

The pin 22 is designed to operate off 5 V.

Moreover, this terminal (pin 22) serves as the source switch of current of an internal mute circuit. And it is designed so that the discharge current of this terminal (pin 22) may serve as 200 μ A. The outside pull-up resistor R_1 is determined on the basis of this value.

ex) When control voltage is changed in to 6 V from 5 V.

$$6 \text{ V}/5 \text{ V} \times 47 \text{ k} = 56 \text{ k}$$

To obtain enough mute attenuation, a series resistor, R_1 at pin 22 should be 47 k Ω or more.

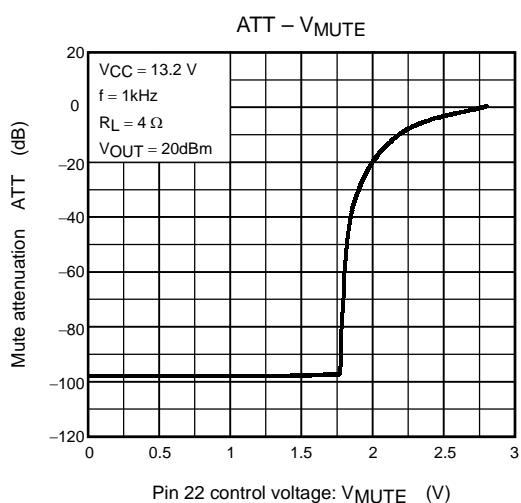
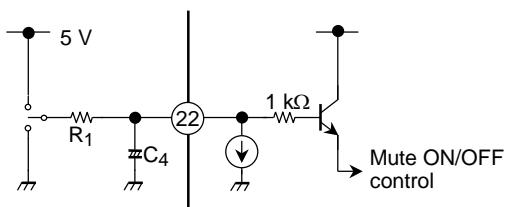


Figure 4 Muting Function

Figure 5 Mute Attenuation - V_{MUTE} (V)

4. High-Side Switch

Pin 25 of this device is used in concerned with Vcc as a high-side switch which operates with the standby pin. Thus, both the power amp IC and the connected external unit (the hideaway unit) can be turned ON/OFF by using of the standby switch.

5. Pop Noise Suppression

Since the AC-GND pin (pin 16) is used as the NF pin for all amps, the ratio between the input capacitance (C1) and the AC-to-GND capacitance (C6) should be 1:4.

Also, if the power is turned OFF before the C1 and C6 batteries have been completely charged, pop noise will be generated because of the DC input umbalance.

To counteract the noise, it is recommended that a longer charging time be used for C2 as well as for C1 and C6. Note that the time which audio output takes to start will be longer, since the C2 makes the muting time (the time from when the power is turned ON to when audio output starts) is fix.

The pop noise which is generated when the muting function is turned ON/OFF will vary according to the time constant of C4.

The greater the capacitance, the lower the pop noise. Note that the time from when the mute control signal is applied to C4 to when the muting function is turned ON/OFF will be longer.

6. External Component Constants

Component Name	Recommended Value	Purpose	Effect		Notes
			Lower than recommended value	Higher than recommended value	
C1	0.22 μ F	To eliminate DC	Cut-off frequency is increased	Cut-off frequency is reduced	Pop noise is generated when V _{CC} is ON
C2	10 μ F	To reduce ripple	Powering ON/OFF is faster	Powering ON/OFF takes longer	
C3	0.1 μ F	To provide sufficient oscillation margin	Reduces noise and provides sufficient oscillation margin		
C4	1 μ F	To reduce pop noise	High pop noise. Duration until muting function is turned ON/OFF is short	Low pop noise. Duration until muting function is turned ON/OFF is long	
C5	3900 μ F	Ripple filter	Power supply ripple filtering		
C6	1 μ F	NF for all outputs	Pop noise is suppressed when C1:C6 = 1:4		

Note: If recommended value is not used.

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Peak supply voltage (0.2 s)	V _{CC} (surge)	50	V
DC supply voltage	V _{CC} (DC)	25	V
Operation supply voltage	V _{CC} (opr)	18	V
Output current (peak)	I _O (peak)	9	A
Power dissipation	P _D (Note 2)	125	W
Operation temperature	T _{opr}	-40~85	°C
Storage temperature	T _{stg}	-55~150	°C

Note 2: Package thermal resistance $\theta_{j-T} = 1^{\circ}\text{C}/\text{W}$ (typ.) (Ta = 25°C, with infinite heat sink)

Electrical Characteristics

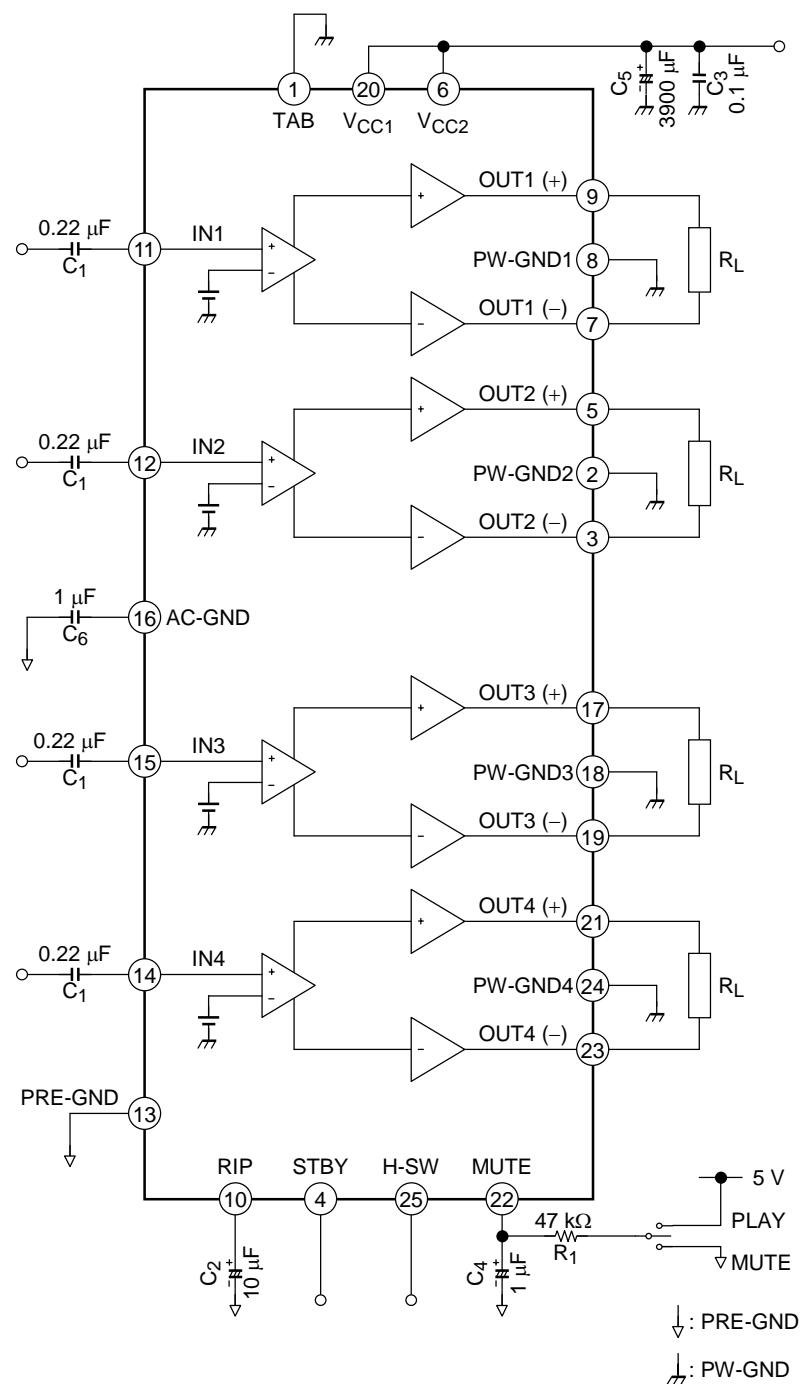
(unless otherwise specified, V_{CC} = 13.2 V, f = 1 kHz, R_L = 4 Ω, Ta = 25°C)

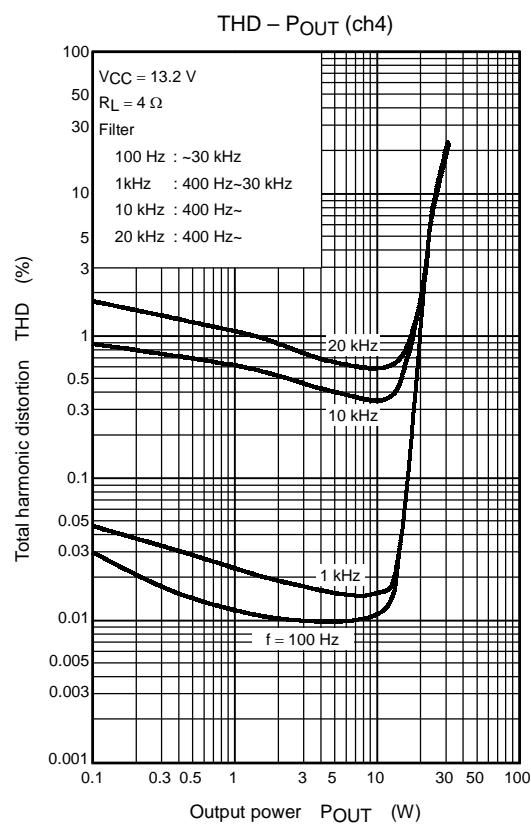
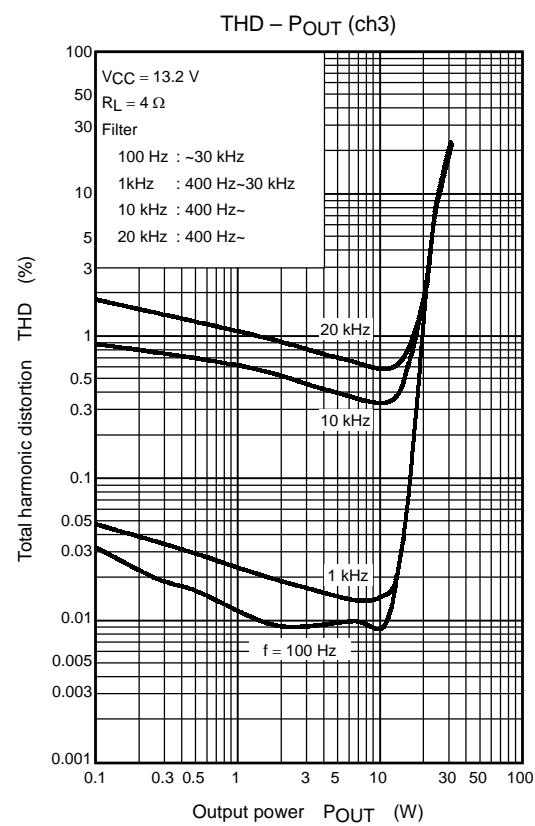
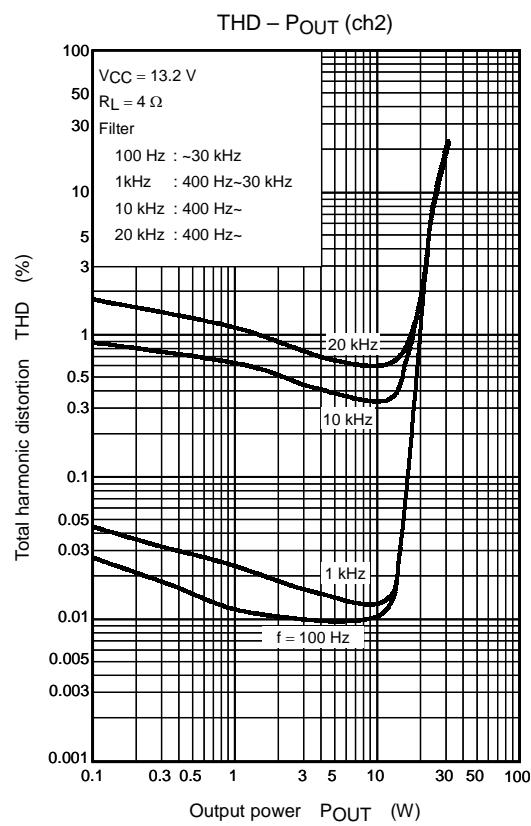
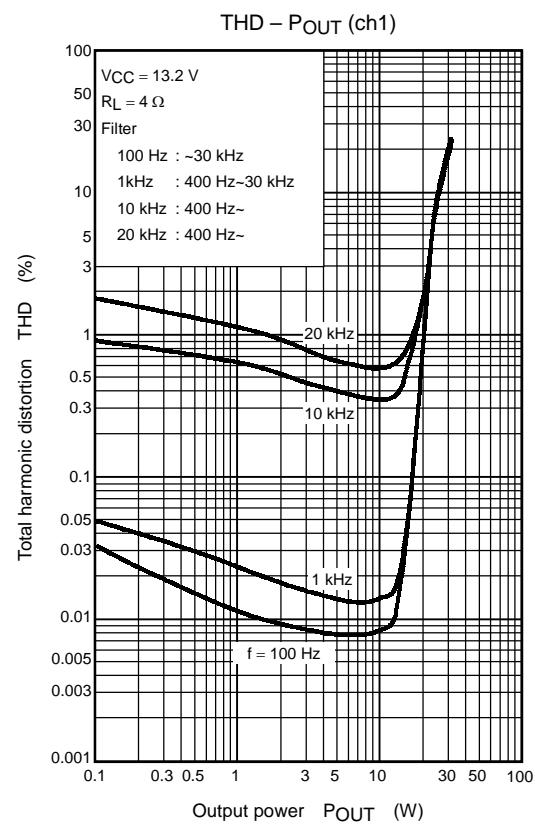
Characteristics	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Quiescent current	I _{CCQ}	—	V _{IN} = 0	—	200	400	mA
Output power	P _{OUT} MAX (1)	—	V _{CC} = 14.4 V, max POWER	—	47	—	W
	P _{OUT} MAX (2)	—	V _{CC} = 13.7 V, max POWER	—	43	—	
	P _{OUT} (1)	—	V _{CC} = 14.4 V, THD = 10%	—	29	—	
	P _{OUT} (2)	—	THD = 10%	23	25	—	
	THD	—	P _{OUT} = 5 W	—	0.015	0.15	%
Voltage gain	G _V	—	V _{OUT} = 0.775 Vrms	24	26	28	dB
Voltage gain ratio	ΔG _V	—	V _{OUT} = 0.775 Vrms	-1.0	0	1.0	dB
Output noise voltage	V _{NO} (1)	—	R _g = 0 Ω, DIN45405	—	100	—	μVrms
	V _{NO} (2)	—	R _g = 0 Ω, BW = 20 Hz~20 kHz	—	90	200	
Ripple rejection ratio	R.R.	—	f _{rip} = 100 Hz, R _g = 620 Ω V _{rip} = 0.775 Vrms	50	60	—	dB
Cross talk	C.T.	—	R _g = 620 Ω V _{OUT} = 0.775 Vrms	—	70	—	dB
Output offset voltage	V _{OFFSET}	—	—	-150	0	150	mV
Input resistance	R _{IN}	—	—	—	90	—	kΩ
Standby current	I _{SB}	—	Standby condition	—	2	10	μA
Standby control voltage	V _{SB} H	—	POWER: ON	3.5	—	6.0	V
	V _{SB} L	—	POWER: OFF	0	—	1.5	
Mute control voltage	V _M H	—	MUTE: OFF	3.0	—	6.0	V
	V _M L	—	MUTE: ON, R ₁ = 47 kΩ	0	—	0.5	
Mute attenuation	ATT M	—	MUTE: ON V _{OUT} = 7.75 Vrms → Mute: OFF	80	90	—	dB

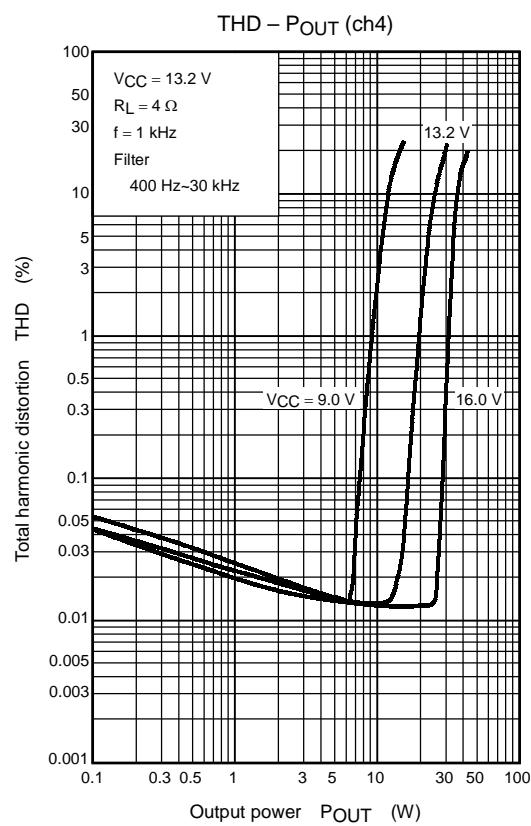
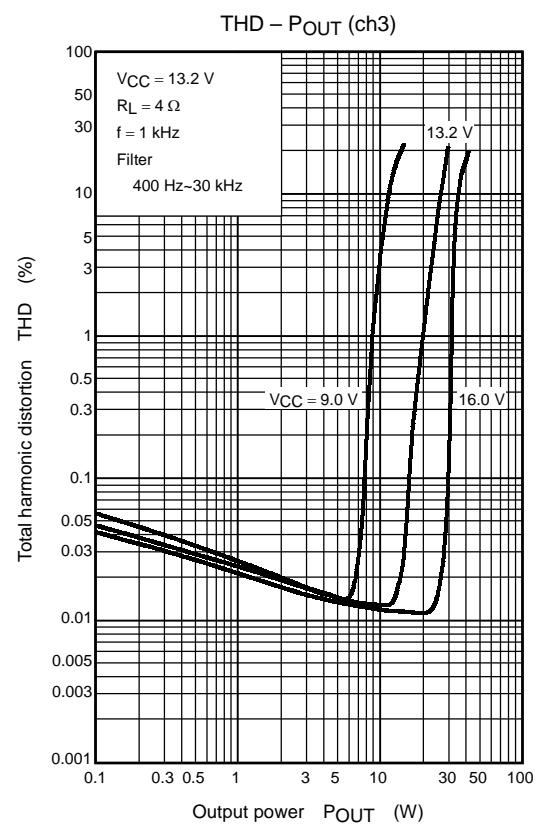
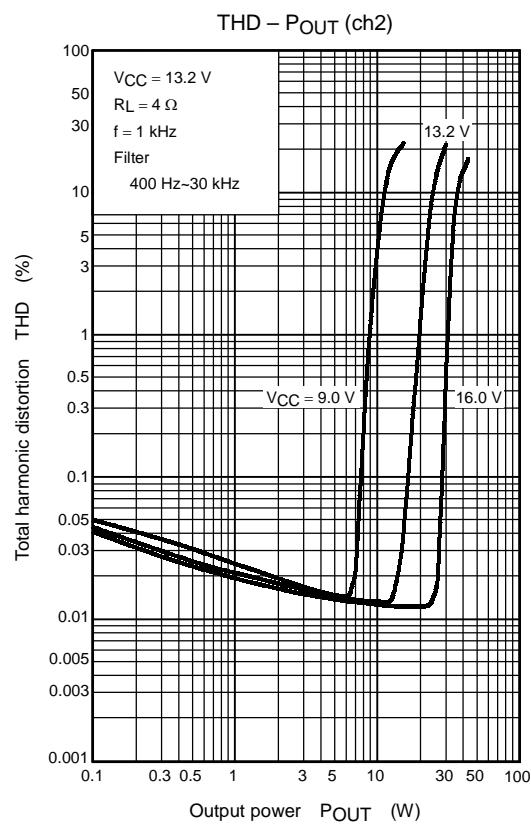
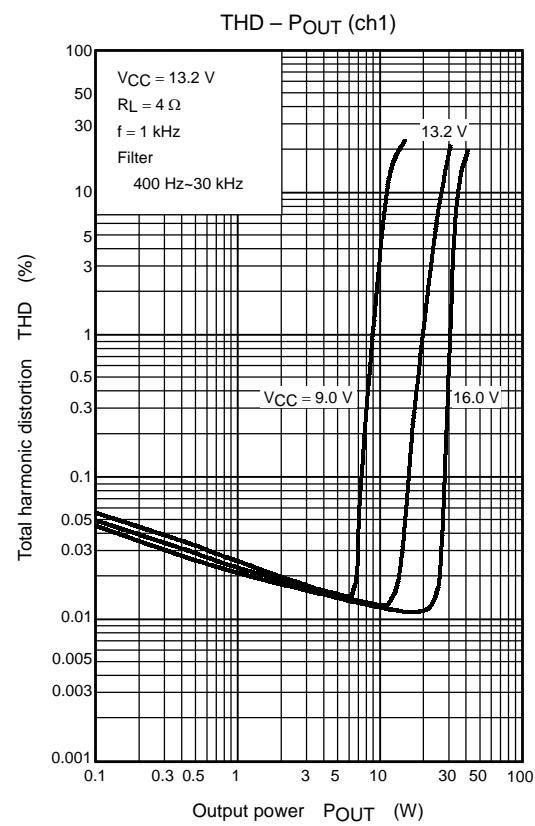
High-Side Switch

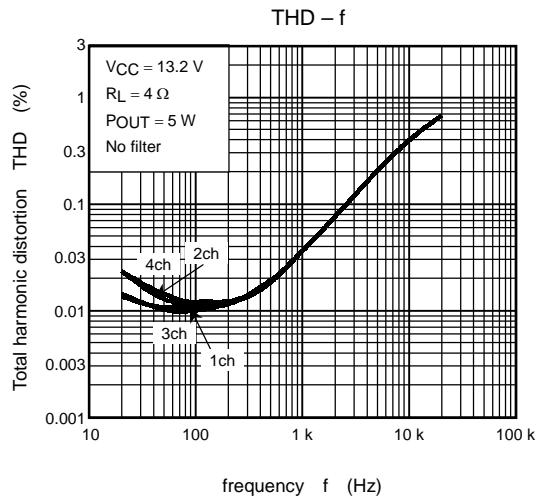
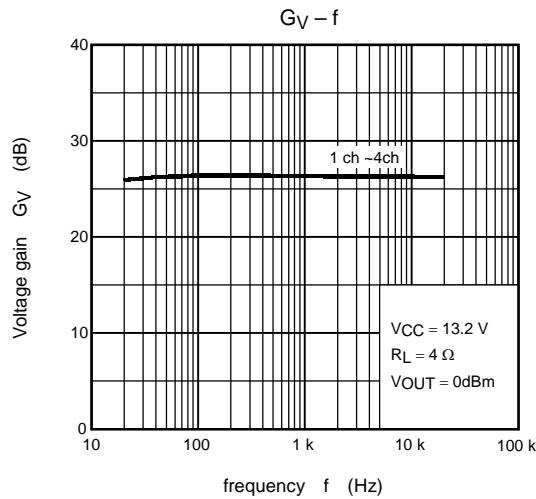
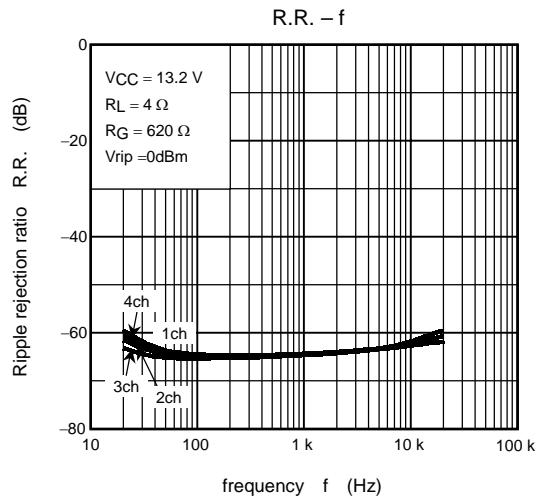
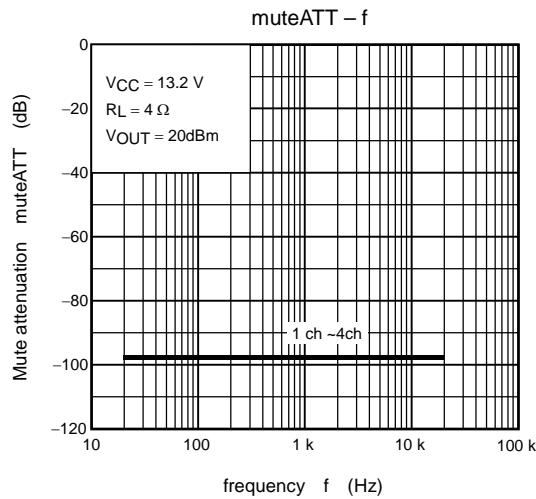
Output current	I _O	—		400	—	—	mA
Difference voltage between V _{CC} and output	ΔV _O	—	I _O = 400 mA, +B = 9.6 V	—	0.25	0.6	V

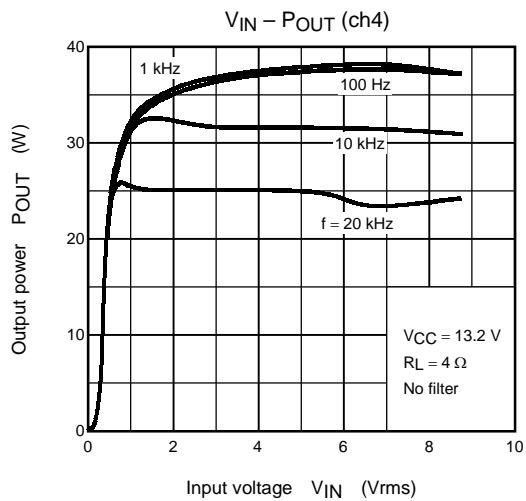
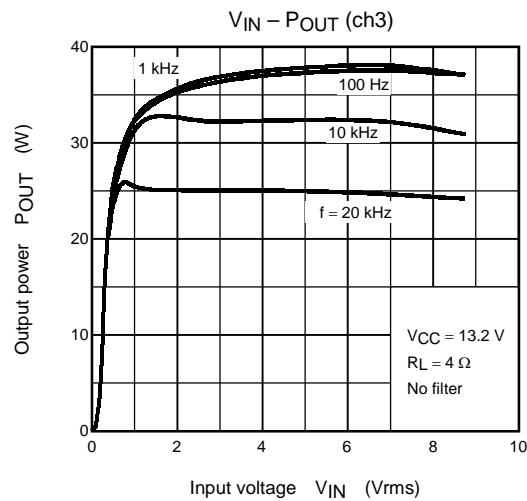
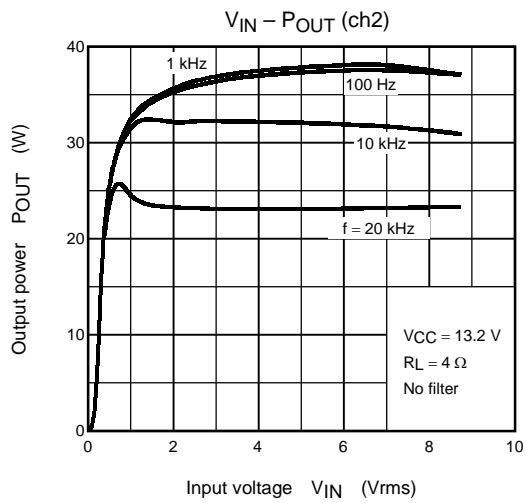
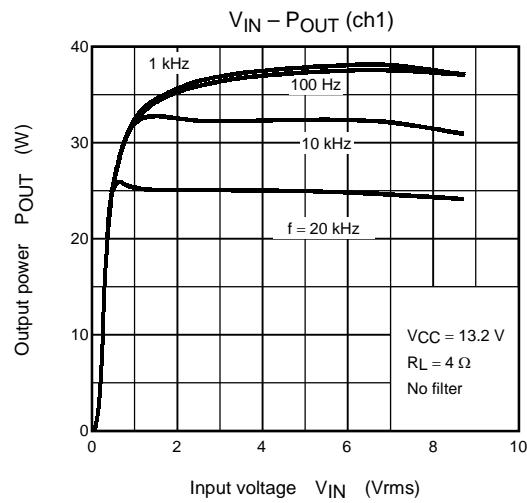
Test Circuit

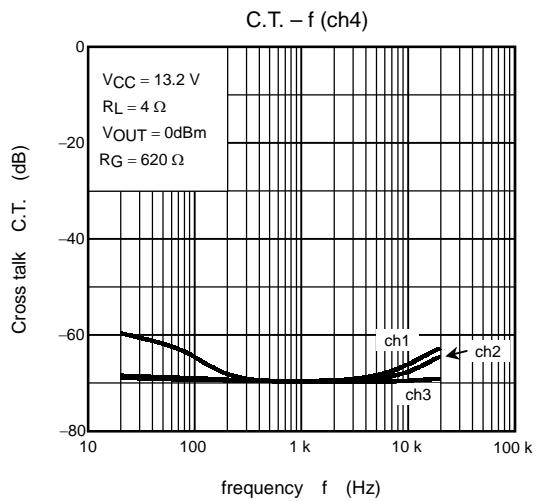
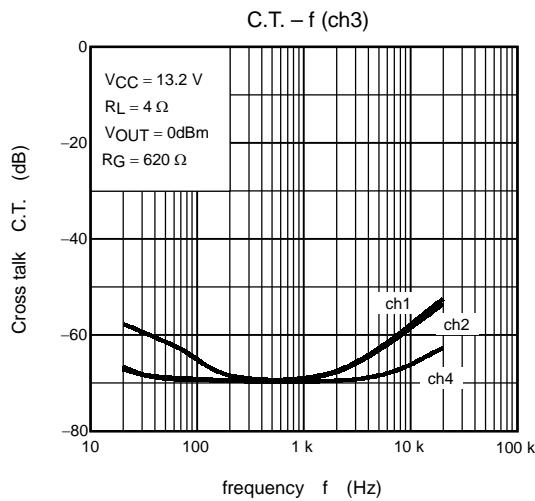
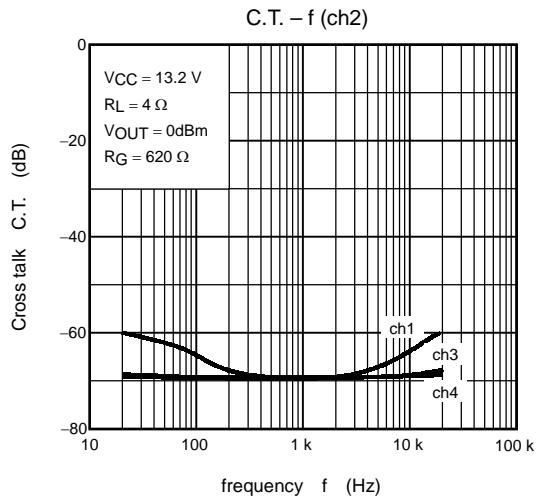
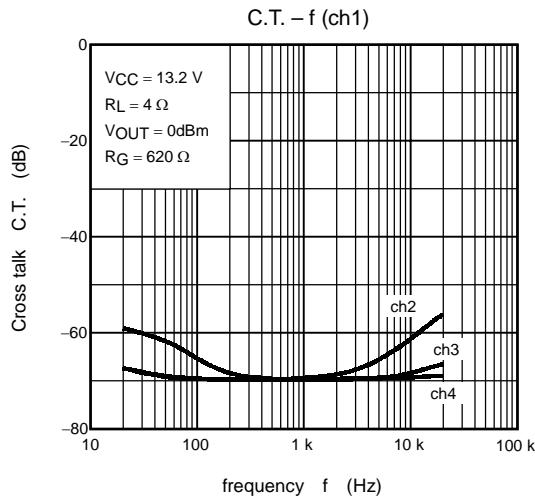


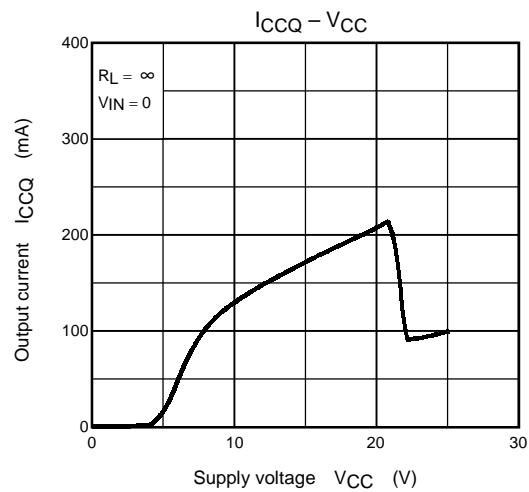
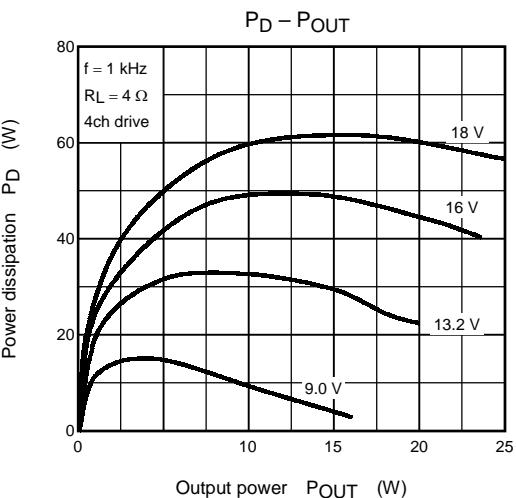
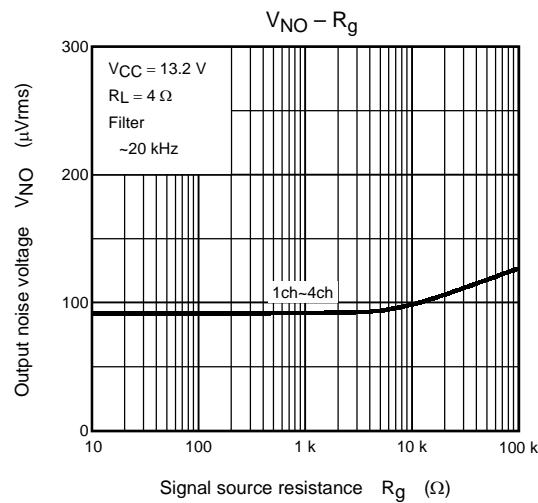








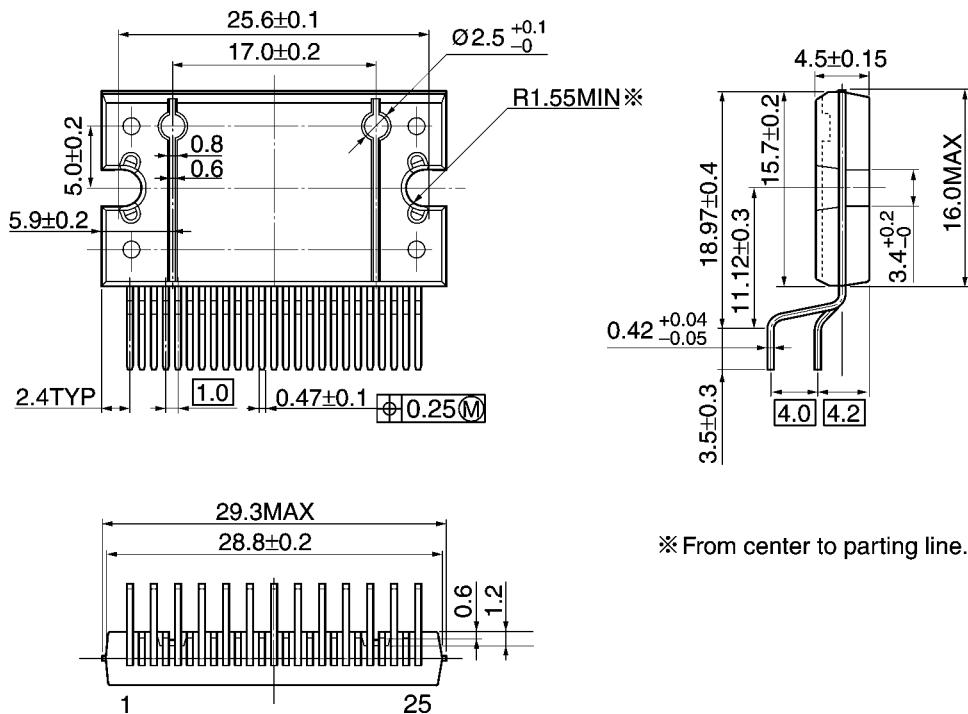




Package Dimensions

HZIP25-P-1.00F

Unit: mm



Weight: 7.7 g (typ.)

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